

TOSHIBA PHOTOINTERRUPTER INFRARED LED + PHOTO IC

TLP1018, TLP1019

HOME ELECTRIC EQUIPMENT SUCH AS VCR, CD PLAYER

OA EQUIPMENT SUCH AS COPYING MACHINE, PRINTER, FACSIMILE, ETC.

AUTOMATIC SERVICE EQUIPMENT SUCH AS VENDING MACHINE,

TICKETING MACHINE, ETC.

VARIOUS POSITION DETECTION

TLP1018 and TLP1019 are digital output photointerrupters combining GaAs infrared LED with high sensitive and high gain Si photo IC.

Directly connectable to TTL, LSTTL and CMOS.

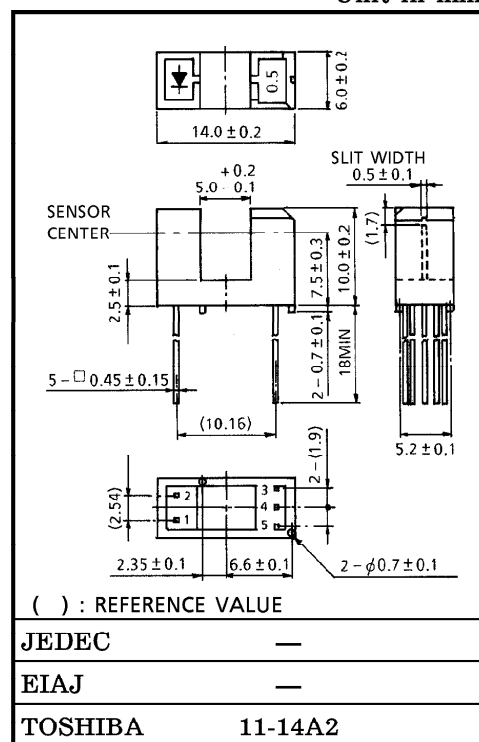
- PWB direct mounting type
- Gap : 5mm
- Resolution : Slit width 0.5mm
- Digital output (open collector)

TLP1018 : Low level output at shielding

TLP1019 : High level output at shielding

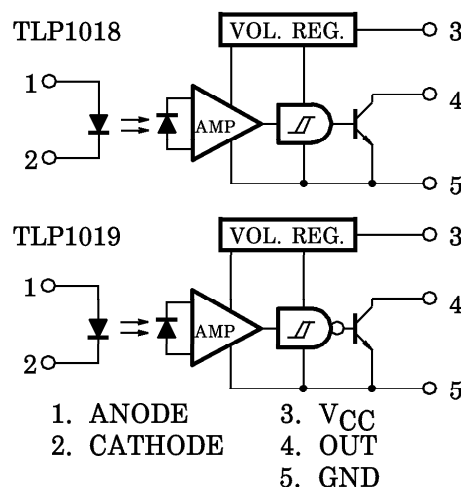
- Built-in Schmitt trigger circuit
- Threshold input current : 6mA (Max.) at $T_a = 25^\circ\text{C}$
- Operating supply voltage : $V_{CC} = 4.5 \sim 17\text{V}$
- Fast response speed
- Detector side is of visible light cut type.

Unit in mm



Weight : 0.68g (Typ.)

PIN CONNECTION



961001EBC2

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- Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.
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MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
LED	Forward Current	I_F	50	mA
	Forward Current Derating (Ta > 25°C)	$\Delta I_F / ^\circ\text{C}$	-0.33	mA / °C
	Reverse Voltage	V_R	5	V
DETECTOR	Supply Voltage	V_{CC}	17	V
	Output Voltage	V_O	30	V
	Output Current	I_O	50	mA
	Power Dissipation	P_O	250	mW
	Power Dissipation Derating (Ta > 25°C)	$\Delta P_O / ^\circ\text{C}$	-3.33	mW / °C
Operating Temperature Range		T_{opr}	-25~85	°C
Storage Temperature Range		T_{stg}	-40~100	°C
Soldering Temperature (5s)		T_{sol}	260	°C

RECOMMENDED OPERATING CONDITION

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
LED Forward Current	I_F	21*	—	25	mA
Supply Voltage	V_{CC}	4.5	5.0	17	V
Output Voltage	V_O	—	5.0	24	V
Low Level Output Current	I_{OL}	—	—	16	mA
Operating Temperature	T_{opr}	-25	—	85	°C

* 21mA is a value when 50% LED deterioration is taken into consideration.
Initial threshold input current shall be 10.5mA MAX.

OPTO-ELECTRICAL CHARACTERISTICS (Unless otherwise specified, Ta = -25~85°C, V_{CC} = 5V ± 10%)

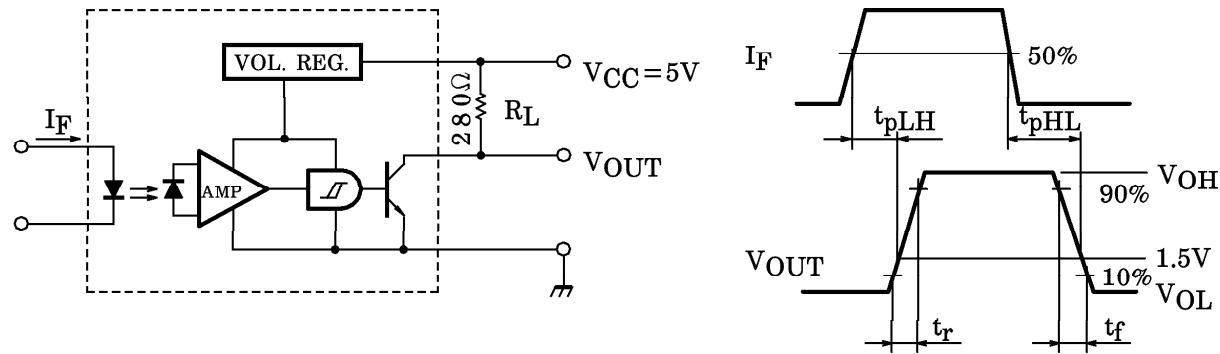
CHARACTERISTIC		SYMBOL	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
LED	Forward Voltage	V _F	I _F =10mA, Ta=25°C		1.00	1.15	1.30	V
	Reverse Current	I _R	V _R =5V, Ta=25°C		—	—	10	μA
	Peak Emission Wavelength	λ _P	I _F =15mA, Ta=25°C		—	940	—	nm
DETECTOR	Supply Voltage	V _{CC}	—		4.5	—	17	V
	Low Level Supply Current	I _{CCL}	I _F =*1		—	—	5.0	mA
			I _F =*1, V _{CC} =17V		—	—	3.2	
	High Level Supply Current	I _{CCH}	I _F =*2		—	—	3.0	mA
			I _F =*2, V _{CC} =17V		—	—	3.2	
	Low Level Output Voltage	V _{OL}	I _{OL} =16mA, I _F =*1 Ta=25°C		—	0.07	0.3	V
			I _{OL} =16mA, I _F =*1 V _{CC} =17V		—	—	0.4	
High Level Output Current	I _{OH}	I _F =*2, V _O =30V		—	—	15	μA	
Peak Sensitivity Wavelength	λ _P	Ta=25°C		—	900	—	nm	
COUPLED	L→H Threshold Input Current	I _{FLH}	Ta=25°C	TLP1018	—	—	6	mA
			V _{CC} =17V		—	—	10.5	
	H→L Threshold Input Current	I _{FHL}	Ta=25°C	TLP1019	—	—	6	mA
			V _{CC} =17V		—	—	10.5	
	Hysteresis Ratio	I _{FHL} /I _{FLH}	—	TLP1018	—	0.67	—	—
				TLP1019	—	1.5	—	
	Propagation Delay Time (L→H)	t _{pLH}	V _{CC} =5V I _F =15mA R _L =280Ω Ta=25°C (Note)	TLP1018	—	3	—	μs
				TLP1019	—	6	—	
	Propagation Delay Time (H→L)	t _{pHL}		TLP1018	—	6	—	
TLP1019				—	3	—		
Rise Time	t _r			—	0.1	—		
Fall Time	t _f			—	0.05	—		

*1. TLP1018 = 0, TLP1019 = 15mA

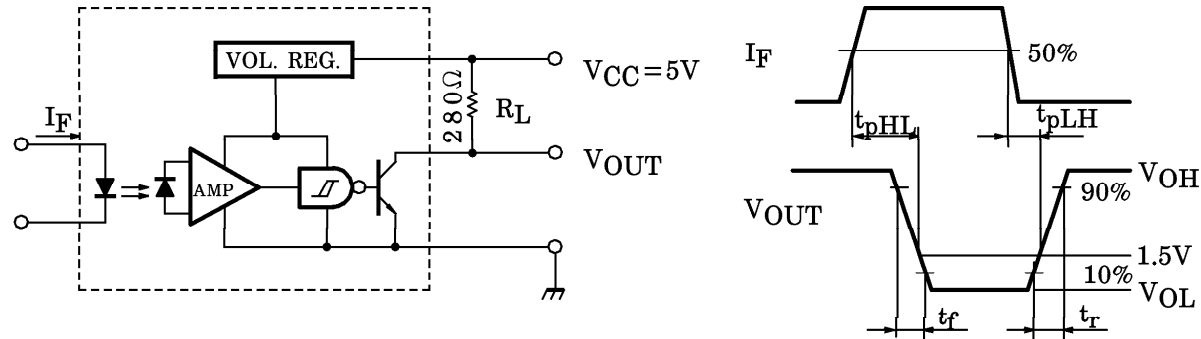
*2. TLP1018 = 15mA, TLP1019 = 0

NOTE : SWITCHING TIME TEST CIRCUIT

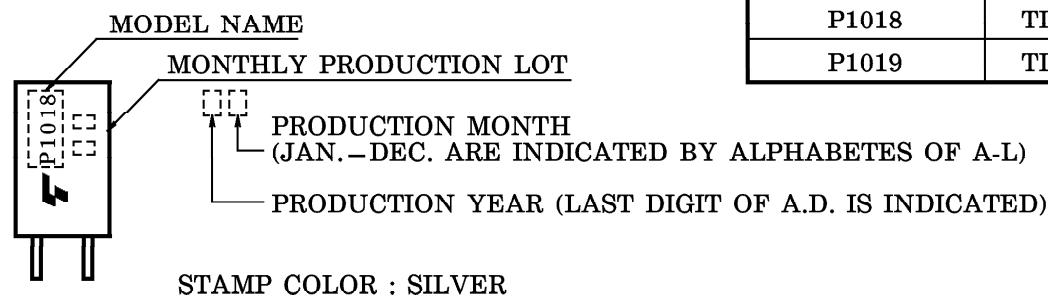
TLP1018



TLP1019



PRODUCT INDICATION



ABBREVIATION	TYPE
P1018	TLP1018
P1019	TLP1019

PRECAUTION

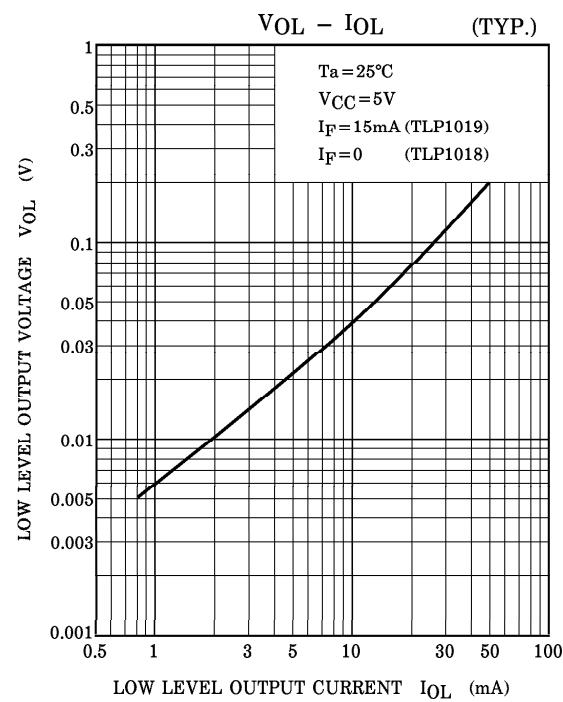
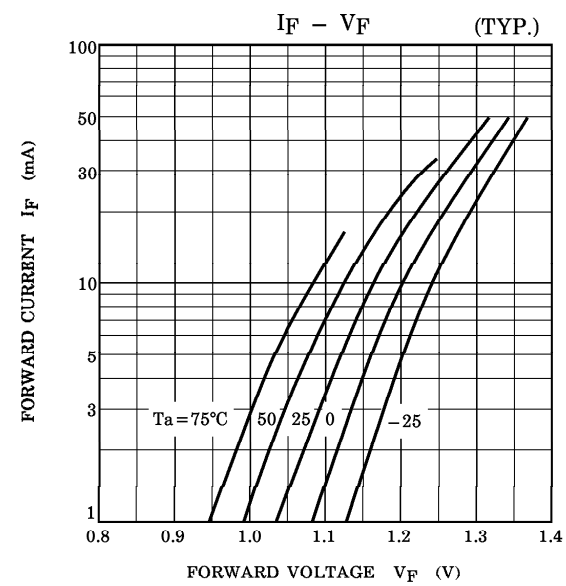
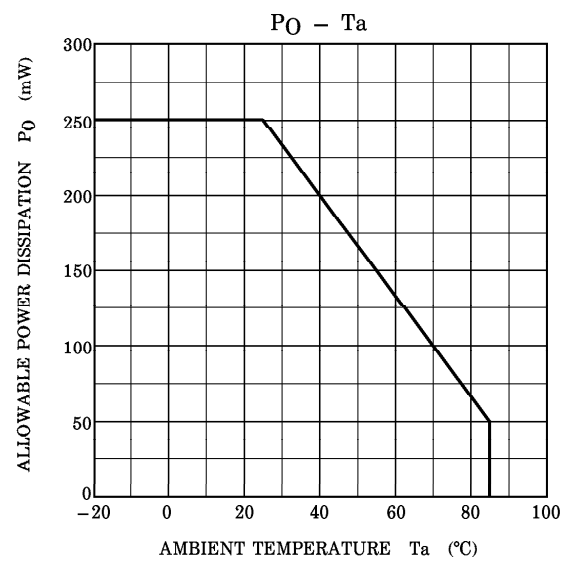
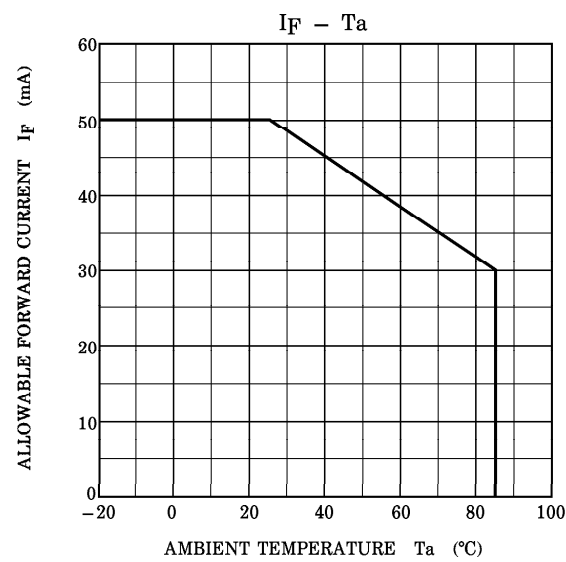
Please be careful of the followings.

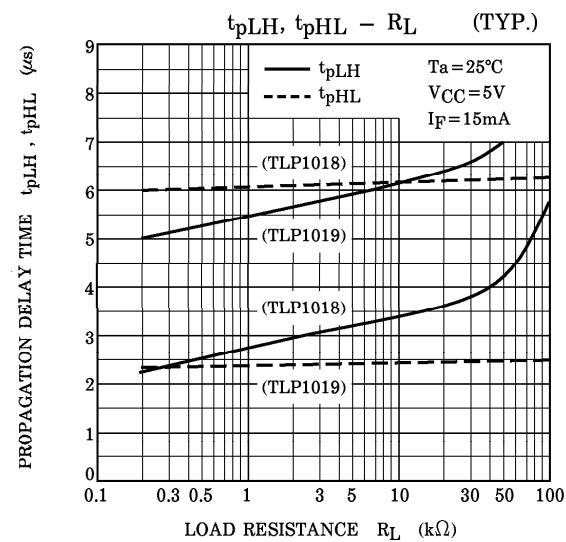
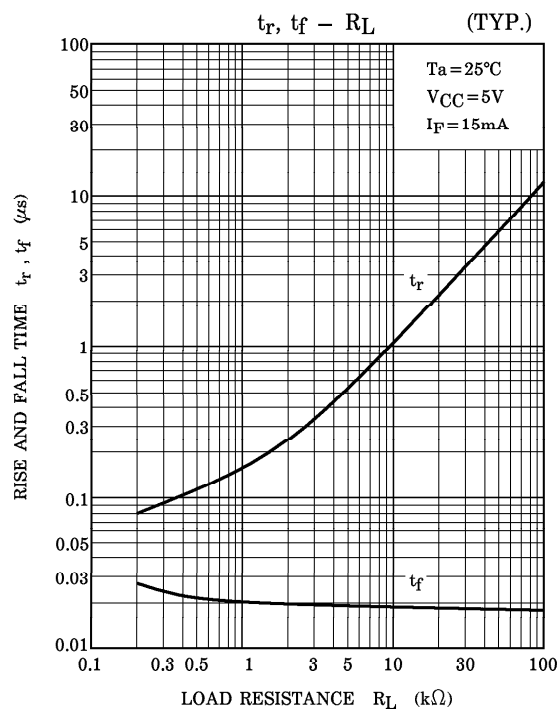
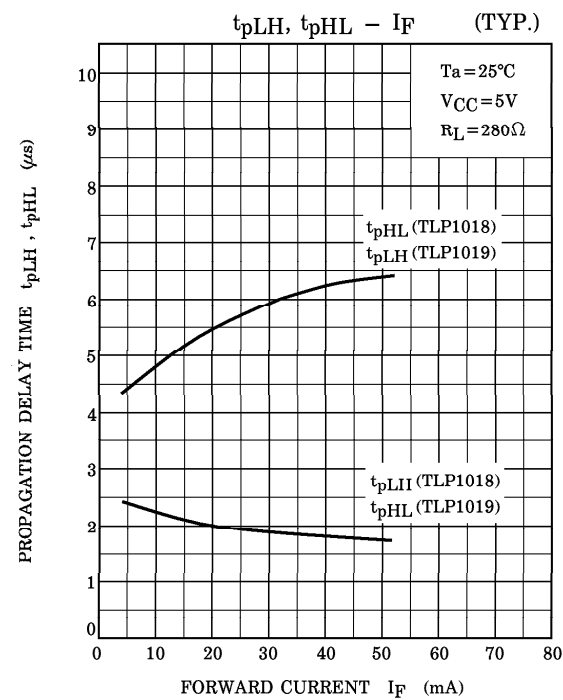
1. Soldering should be performed after lead forming.
2. If chemicals are used for cleaning, the soldered surface only shall be cleaned with chemicals avoiding the whole cleaning of the package.
3. The container is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol, and aliphatic hydrocarbons however, with peroxochemicals (such as benzene, toluene, and acetone), alkali, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate becomes cracked, swollen, or melted. Please take care when choosing a packaging material by referencing the table below.

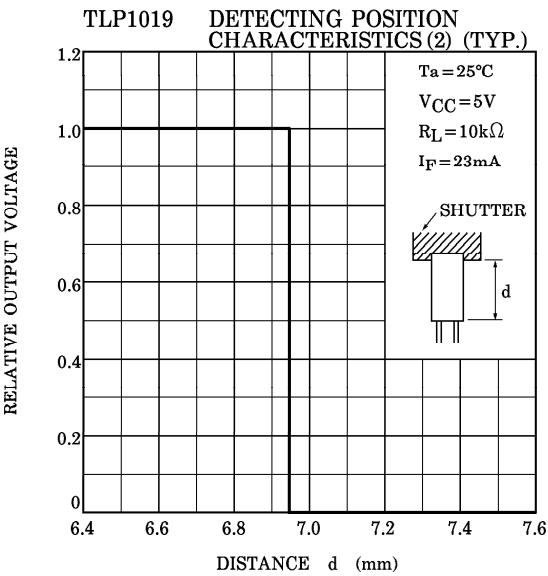
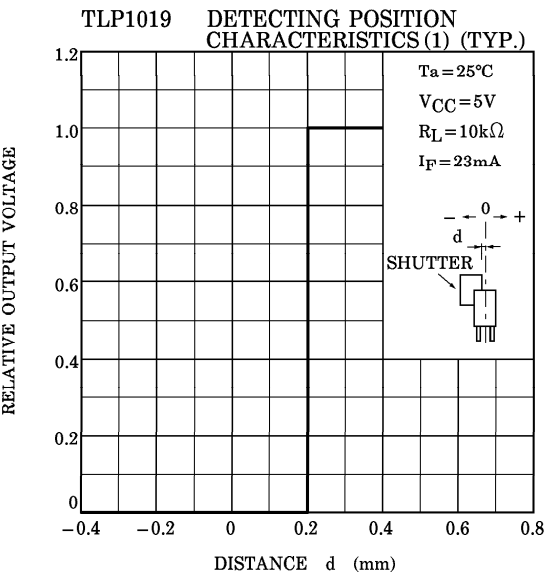
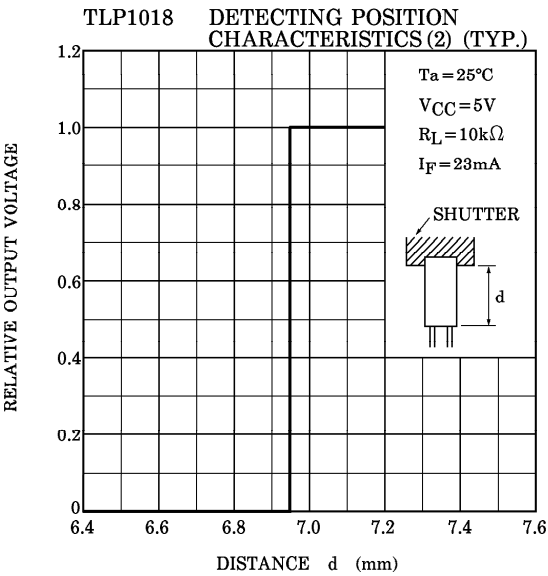
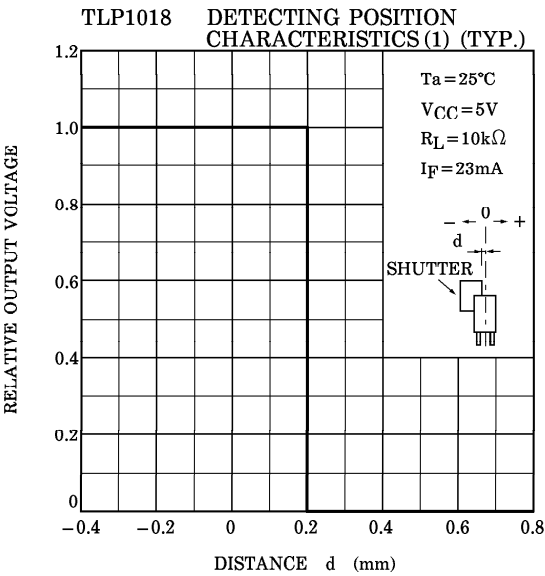
<Chemicals to avoid with polycarbonate>

	PHENOMENON	CHEMICALS
A	Little deterioration but staining	• nitric acid (low concentration), hydrogen peroxide, chlorine
B	Cracked, crazed, or swollen	• acetic acid (70% or more) • gasoline • methyl ethyl ketone, ethyl acetate, butyl acetate • ethyl methacrylate, ethyl ether, MEK • acetone, m-amino alcohol, carbon tetrachloride • carbon disulfide, trichloroethylene, cresol • thinners, oil of turpentine • triethanolamine, TCP, TBP
C	Melted { } : Used as solvent.	• concentrated sulfuric acid • benzene • styrene, acrylonitrile, vinyl acetate • ethylenediamine, diethylenediamine • {chloroform, methyl chloride, tetrachloromethane, dioxane, } 1, 2-dichloroethane
D	Decomposed	• ammonia water • other alkali

4. During 100 μ s after turning on V_{CC}, output voltage changes for stabilizing the inner circuit.
5. Supply the by-pass condenser up to 0.01 μ F between V_{CC} and GND near device to stabilize the power supply line.







POSITIONING OF SHUTTER AND DEVICE

To operate correctly, make sure that the shutter and the device are positioned as shown in the figure below.

The shift pitch of the shutter must be set wider than the slit width of the device.
Determine the width taking the switching time into consideration.

